

STPS20M120S

Power Schottky rectifier

Datasheet - production data

Features

- High current capability
- Avalanche rated
- Low forward voltage drop
- High frequency operation

Description

This Schottky diode is suited for high frequency switch mode power supply.

Packaged in TO-220AB narrow leads and I²PAK, this device is intended to be used in notebook, game station and desktop adapters, providing in these applications a good efficiency at both low and high load.





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This is information on a product in full production.



Table 1.Device summary

Symbol	Value
I _{F(AV)}	20 A
V _{RRM}	120 V
V _F (typ)	0.47 V
T _j (max)	150 °C

a. V_{ARM} and I_{ARM} must respect the reverse safe operating area defined in *Figure 9*. V_{AR} and I_{AR} are pulse measurements ($t_p < 10 \ \mu$ s). V_R, I_R, V_{RRM} and V_F, are static characteristics

1 **Characteristics**

Absolute ratings (limiting values with terminals 1 and 3 short circuited at Table 2. T_{amb} = 25 °C, unless otherwise specified)

Symbo I	Parameter				Unit
V _{RRM}	Repetitive peak reverse v	/oltage		120	V
I _{F(RMS)}	Forward rms current			50	А
I _{F(AV)}	Average forward current,	$\delta = 0.5$	T _c = 125 °C	20	А
I _{FSM}	Surge non repetitive forw	ard current	t_p = 10 ms sinusoidal, T _c = 25 °C	240	А
$P_{ARM}^{(1)}$	Repetitive peak avalanch	ie power $T_j = 125 \text{ °C}, t_p = 10 \mu\text{s}$			W
V _{ARM} ⁽²⁾	Maximum repetitive peak avalanche voltage	t _p < 10 μs, T _j < 125 °C, I _{AR} < 8 A			V
V _{ASM} ⁽²⁾	Maximum single-pulse peak avalanche voltage	t _p < 10 μs, T _j < 125 °C, I _{AR} < 8 A			V
T _{stg}	Storage temperature ran	ge			°C
Тj	Maximum operating junction temperature ⁽³⁾				°C

For pulse time duration deratings, please refer to *Figure 4*. More details regarding the avalanche energy measurements and diode validation in the avalanche are provided in the STMicroelectronics Application notes AN1768, "Admissible avalanche power of schottky diodes" and AN2025, "Converter improvement using Schottky rectifier avalanche specification".

2. See Figure 9

 $\frac{dPtot}{dTj} < \frac{1}{Rth(j-a)}$ condition to avoid thermal runaway for a diode on its own heatsink З.

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
R _{th(j-c)}	Junction to case	1.35	°C/W

Table 4.	Static electrical	characteristics	(terminals 1	and 3 short circuited)
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Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I _R ⁽¹⁾ Re cu	Reverse leakage	T _j = 25 °C	VV_	-	55	275	μA
	current	T _j = 125 °C	V _R = V _{RRM}	-	20	50	mA
V _F ⁽²⁾	Forward voltage drop	T _j = 125 °C	I _F = 5 A	-	0.47	0.52	
		T _j = 25 °C	I _F = 10 A	-		0.72	
		T _j = 125 °C		-	0.52	0.57	V
		T _j = 25 °C		-		0.84	
		T _j = 125 °C	F = 20 A	-	0.63	0.69	

1. Pulse test: $t_p = 5 \text{ ms}, \delta < 2\%$

2. Pulse test: $t_p = 380 \ \mu s, \ \delta < 2\%$

To evaluate the conduction losses use the following equation: P = 0.54 x ${I_{F(AV)}} + 0.0075 \ x \,{I_{F(RMS)}}^2$



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Figure 2. Average forward power dissipation Figure 3. Average forward current versus average forward current ambient temperature ($\delta = 0.5$)

Figure 4. Normalized avalanche power derating versus pulse duration











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Figure 8. Forward voltage drop versus

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2 Package information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)
- Recommended torque value: 0.4 to 0.6 N·m

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: <u>www.st.com</u>. ECOPACK[®] is an ST trademark.

Table 5. TO-220AB narrow leads dimensions

		Dimensions					
	Ref.	Millimeters		rs	Inches		
		Min.	Тур.	Max.	Min.	Тур.	Max.
	А	4.40		4.60	0.17		0.18
	b	0.61		0.88	0.024		0.034
øp – A –	b1	0.95		1.20	0.037		0.047
	с	0.48		0.70	0.019		0.027
	D	15.25		15.75	0.60		0.62
	D1		1.27			0.05	
	Е	10.00		10.40	0.39		0.41
	е	2.40		2.70	0.094		0.106
b1(x3)-	e1	4.95		5.15	0.19		0.20
	F	1.23		1.32	0.048		0.052
	H1	6.20		6.60	0.24		0.26
-= b (x3)	J1	2.40		2.72	0.095		0.107
-e1-	L	13.00		14.00	0.51		0.55
	L1	2.60		2.90	0.102		0.114
	L20		15.40			0.61	
	L30		28.90			1.14	
	ØP	3.75		3.85	0.147		0.151
	Q	2.65		2.95	0.104		0.116

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Devices in I²PAK with nickel-plated back frame must NOT be mounted by frame soldering like SMDs. Such devices are intended to be through-hole mounted ONLY and in no circumstances shall ST be held liable for any lack of performance or damage arising out of soldering of nickel-plated back frames.



Table 6.I²PAK dimensions



3 Ordering information

Table 7. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS20M120SR	PS20M120SR	I ² PAK	1.49 g	50	Tube
STPS20M120STN	PS20M120STN	TO-220AB narrow leads	1.9 g	50	Tube

4 Revision history

Table 8. Document revision history

Date	Revision	Changes
02-Apr-2012	1	First issue.



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